THE INFORMATION CONTAINED HEREIN IS CONSIDERED "PROPRIETARY" TO BEL FUSE INC. AND SHALL NOT BE COPIED, REPRODUCED OR DISCLOSED WITHOUT THE WRITTEN APPROVAL OF BEL FUSE INC.

CHIP SIDE

TD+ 1 •

TCT 2 ◆

TD- 3 •

4 •

5 •

RD+ 6 •

RCT 7 ◆

RD-8

SCHEMATIC

 $\sim$ 

 $\mathcal{M}$ 

TITLE

1CT : 1CT

1CT : 1CT

## Designed to accommodate 350mA of balanced DC as stipulated in IEEE 802.3af

LINE SIDE

→ 16 TX+

◆ 15 TXCT

→ 14 TX-

• 13

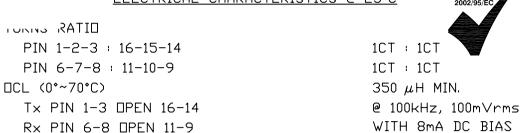
• 12

• 11 RX+

10 RXCT

9 RX-

## ELECTRICAL CHARACTERISTICS @ 25°C



LEAKAGE INDUCTANCE, LI  $0.30~\mu H$  MAX. @ 1MHz, 20mV Tx PIN 1-3 SHORT 16-14

Rx PIN 6-8 SHORT 11-9

INTERWINDING CAPACITANCE, Cw/w 30 pF MAX.

@ 1MHz, 20mV

 $18-20 L \Box G (f/30MHz)$ 

12 dB MIN.

35 dB MIN.

RoHS

Tx PIN 1-3 TD 16-14 R× PIN 6-8 TD 11-9

DCR

PIN (1-3); (6-8) 1.1 ∏hm MAX.

INSERTION LOSS

1.2 dB MAX. 1 MHz T□ 100 MHz

RETURN LOSS

1 MHz - 30 MHz 18 dB MIN.

30 MHz -60 MHz 60 MHz - 80 MHz

COMMON TO DIFFERENTIAL 35 dB MIN.

100 kHz - 100 MHz

CROSSTALK 100 kHz - 100 MHz

HIPOT PER HAND-WORK-03

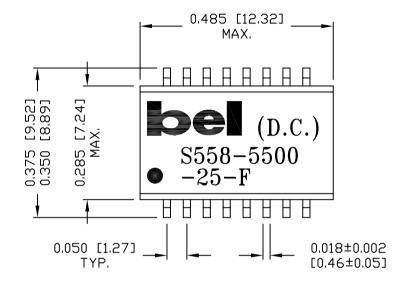
| ORIGINATED BY  | DATE     |  |  |
|----------------|----------|--|--|
| HO             | 07-19-05 |  |  |
| DRAWN BY       | DATE     |  |  |
| DQ Chen        | 07-19-05 |  |  |
| DC002(2)032305 |          |  |  |

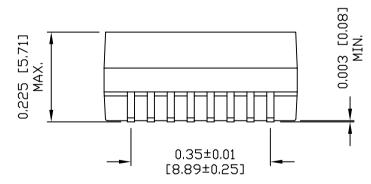
VOIP INTERFACE MODULE \$558-5500-25-F

| PART NO. / DRAWING NO. | STANDARD DIM. |  | [ ] METRIC DIM. AS REFERENCE |          |  |
|------------------------|---------------|--|------------------------------|----------|--|
| X558550025-F           | TOL. IN INCH  |  | UNIT : INCH [mm]             | REV. : A |  |
| FILE NAME              | .XX           |  | SCALE: N/A                   | SIZE: A4 |  |
| X558550025FA.DWG       | .XXX          |  |                              | PAGE: 2  |  |



THE INFORMATION CONTAINED HEREIN IS CONSIDERED 'PROPRIETARY' TO BEL FUSE INC. AND SHALL NOT BE COPIED, REPRODUCED OR DISCLOSED WITHOUT THE WRITTEN APPROVAL OF BEL FUSE INC.



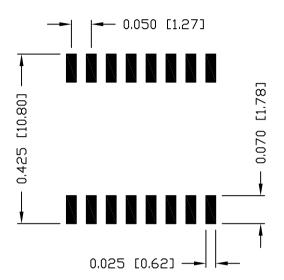


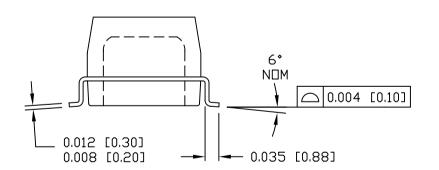
- 1. STANDARD MARKING REFER TO DOC. HAND-WORK-04.
- 2. PACKAGE CODE: "QBS001".

NOTES:

## SUGGESTED PCB PAD LAYDUT

RoHS





| ORIGINATED BY  | DATE  | TITLE              | PART NO. / DRAWING NO. | STANDARD DIM. | [ ] METRIC DIM. AS REFERENCE |  |  |
|----------------|---|--------------------|------------------------|---------------|------------------------------|--|--|
| нп             | 07-19-05  | MECHANICAL DRAWING | X558550025-F           | TOL. IN INCH  | UNIT : INCH [mm] REV. : A    |  |  |
| DRAWN BY       | DATE  | \$558-5500-25-F    | FILE NAME              | .X ±0.01      | SCALE: N/A SIZE: A4          |  |  |
| DQ Chen        | 07-19-05  |                    | X558550025FA.DWG       | .XXX ±0.005   | <b>PAGE</b> : 3              |  |  |
| DC002(2)032305 | C002(2)032305 This document is electronically generated. This is a controlled copy if used internally |                    |                        |               |                              |  |  |